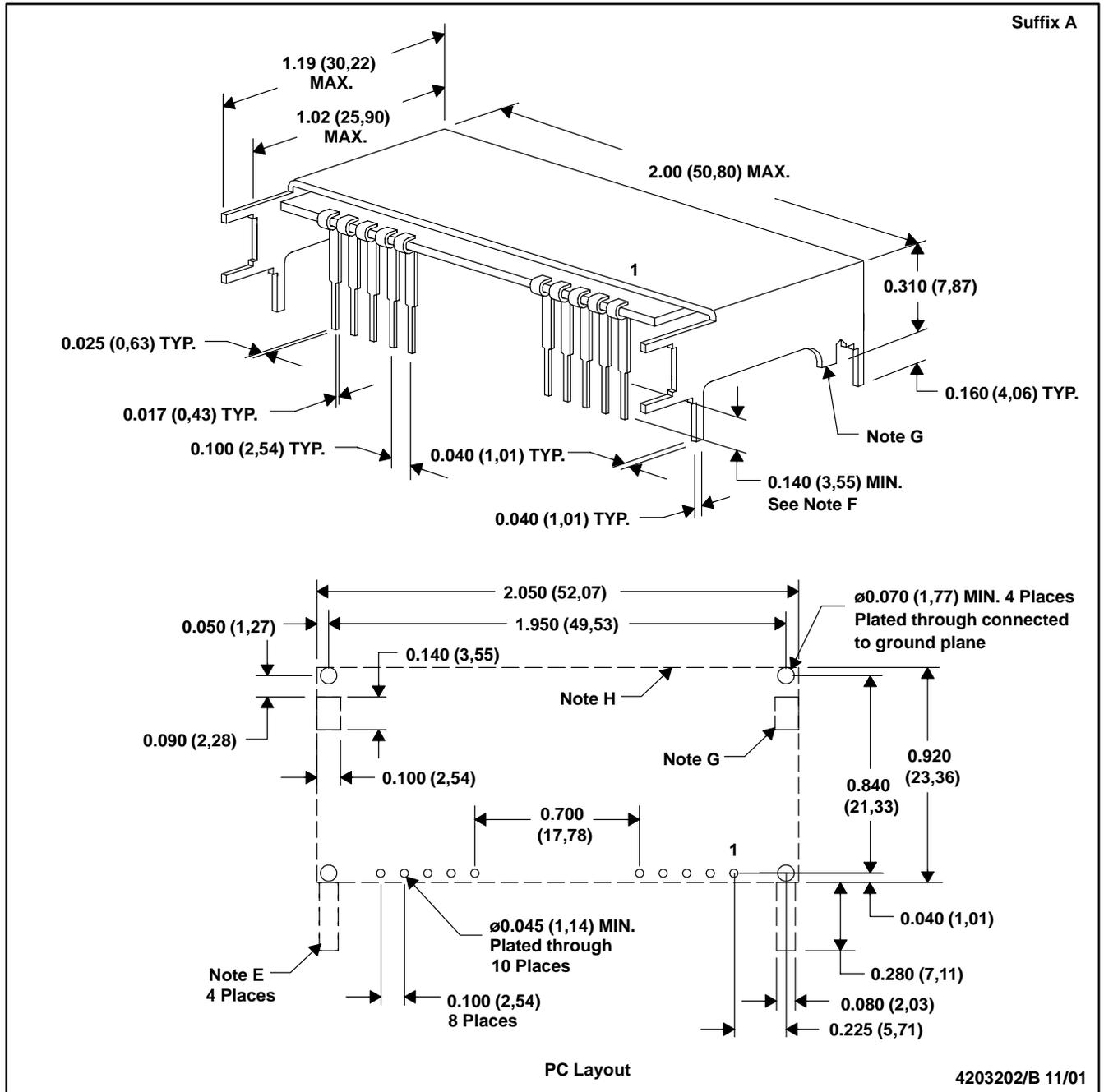


EPF (R-MSIP-T10)

METAL SINGLE-IN-LINE MODULE



- NOTES: A. All linear dimensions are in inches (mm).
 B. This drawing is subject to change without notice.
 C. 2 place decimals are ± 0.030 ($\pm 0,76$ mm).
 D. 3 place decimals are ± 0.010 ($\pm 0,25$ mm).
 E. Recommended mechanical keep out area.
 F. Electrical pin length mounted on circuit board seating plane to pin end.
 G. Case is electrically uncommitted. The recommended connection is to secondary ground.
 H. Case outline reference.

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